Avalanche Technology, headquartered in Fremont, California, is the world leader in Spin Transfer Torque Magnetic RAM (STT-MRAM) non-volatile memory leveraging perpendicular magnetic tunnel jjunction (pMTJ) cell structure manufactured on 300mm standard CMOS process.

Discrete MRAM

Avalanche's Persistent SRAM (P-SRAM) is a non-volatile memory utilizing an advanced pMTJ STT-MRAM technology and is offered with either a Serial Peripheral Interface (SPI) or a parallel interface (x8/x16). Ideal for the following applications:

| | Accordoa* | Acrospas & Defense* | Industrial | |
|--|--|---|--|--|
| | Aerospace* | Aerospace & Defence* | industrial | |
| | | cessors and FPGAs are used in on-board computing | Serial High Performance | |
| | • | pons systems, human-rated spacecraft, habitats and ns. System applications range from small satellites to | 1Mb, 4Mb, 8Mb, 16Mb | |
| | | FPGAs need highly reliable boot code and configura- | 1.8V (1.71V to 2.00V) 3.0V (2.70V to 3.60V) | |
| | · · · · · | 22nm high reliability pMTJ STT-MRAM enables the | 8-pad WSON, 8-pin SOIC, 24-ball FBGA | |
| and defense a | on of distributed edge processing in spa applications. | Industrial (-40°C to 85°C), Industrial Plus (-40°C to 105°C) | | |
| | Serial QSPI Space Grade (Gen 1) | Serial QSPI Space Grade (Gen 3) | Serial SPI | |
| | | | | |
| Densities | 4Mb, 8Mb | 512Mb, 1Gb | 1Mb, 4Mb, 8Mb, 16Mb | |
| Densities Voltages | 4Mb, 8Mb 1.8V (1.70V to 2.00V) | 512Mb, 1Gb 1.8V (1.71V to 2.00V) 3.0V (2.70V to 3.60V) | | |
| | | 1.8V (1.71V to 2.00V) | 1Mb, 4Mb, 8Mb, 16Mb | |
| Voltages | 1.8V (1.70V to 2.00V) | 1.8V (1.71V to 2.00V) 3.0V (2.70V to 3.60V) | 1Mb, 4Mb, 8Mb, 16Mb 3.0V (2.70V to 3.60V) | |
| Voltages Packages Temperature | 1.8V (1.70V to 2.00V) 8-pin WSON, 16-pin SOIC | 1.8V (1.71V to 2.00V) 3.0V (2.70V to 3.60V) 36-ball FBGA | 1Mb, 4Mb, 8Mb, 16Mb 3.0V (2.70V to 3.60V) 8-pad WSON, 8-pin SOIC Industrial (-40°C to 85°C), | |
| Voltages Packages Temperature | 1.8V (1.70V to 2.00V) 8-pin WSON, 16-pin SOIC Aerospace (-40°C to 105°C) | 1.8V (1.71V to 2.00V) 3.0V (2.70V to 3.60V) 36-ball FBGA Aerospace (-40°C to 125°C) | 1Mb, 4Mb, 8Mb, 16Mb 3.0V (2.70V to 3.60V) 8-pad WSON, 8-pin SOIC Industrial (-40°C to 85°C), Industrial Plus (-40°C to 105°C) | |
| Voltages Packages Temperature Ranges | 1.8V (1.70V to 2.00V) 8-pin WSON, 16-pin SOIC Aerospace (-40°C to 105°C) Serial Space Grade (Gen 2) | 1.8V (1.71V to 2.00V) 3.0V (2.70V to 3.60V) 36-ball FBGA Aerospace (-40°C to 125°C) Parallel x32 Space Grade (Gen 3) | 1Mb, 4Mb, 8Mb, 16Mb 3.0V (2.70V to 3.60V) 8-pad WSON, 8-pin SOIC Industrial (-40°C to 85°C), Industrial Plus (-40°C to 105°C) | |
| Voltages Packages Temperature Ranges Densities | 1.8V (1.70V to 2.00V) 8-pin WSON, 16-pin SOIC Aerospace (-40°C to 105°C) Serial Space Grade (Gen 2) 16Mb 1.8V (1.71V to 2.00V) | 1.8V (1.71V to 2.00V) 3.0V (2.70V to 3.60V) 36-ball FBGA Aerospace (-40°C to 125°C) Parallel x32 Space Grade (Gen 3) 512Mb, 1Gb, 2Gb, 4Gb | 1Mb, 4Mb, 8Mb, 16Mb 3.0V (2.70V to 3.60V) 8-pad WSON, 8-pin SOIC Industrial (-40°C to 85°C), Industrial Plus (-40°C to 105°C) Parallel x8 | |
| Voltages Packages Temperature Ranges Densities Voltages | 1.8V (1.70V to 2.00V) 8-pin WSON, 16-pin SOIC Aerospace (-40°C to 105°C) Serial Space Grade (Gen 2) 16Mb 1.8V (1.71V to 2.00V) 3.0V (2.70V to 3.60V) | 1.8V (1.71V to 2.00V) 3.0V (2.70V to 3.60V) 36-ball FBGA Aerospace (-40°C to 125°C) Parallel x32 Space Grade (Gen 3) 512Mb, 1Gb, 2Gb, 4Gb 3.0V (2.70V to 3.60V) | 1Mb, 4Mb, 8Mb, 16Mb 3.0V (2.70V to 3.60V) 8-pad WSON, 8-pin SOIC Industrial (-40°C to 85°C), Industrial Plus (-40°C to 105°C) Parallel x8 1Mb, 4Mb, 8Mb, 16Mb, 32Mb 3.0V (2.70V to 3.60V) | |
| Voltages Packages Temperature Ranges Densities Voltages Packages Temperature | 1.8V (1.70V to 2.00V) 8-pin WSON, 16-pin SOIC Aerospace (-40°C to 105°C) Serial Space Grade (Gen 2) 16Mb 1.8V (1.71V to 2.00V) 3.0V (2.70V to 3.60V) 8-pin WSON, 8-pin SOIC | 1.8V (1.71V to 2.00V) 3.0V (2.70V to 3.60V) 36-ball FBGA Aerospace (-40°C to 125°C) Parallel x32 Space Grade (Gen 3) 512Mb, 1Gb, 2Gb, 4Gb 3.0V (2.70V to 3.60V) 142-ball FBGA | 1Mb, 4Mb, 8Mb, 16Mb 3.0V (2.70V to 3.60V) 8-pad WSON, 8-pin SOIC Industrial (-40°C to 85°C), Industrial Plus (-40°C to 105°C) Parallel x8 1Mb, 4Mb, 8Mb, 16Mb, 32Mb 3.0V (2.70V to 3.60V) 44-pin TSOP, 48-ball FBGA Industrial (-40°C to 85°C), | |
| Voltages Packages Temperature Ranges Densities Voltages Packages Temperature | 1.8V (1.70V to 2.00V) 8-pin WSON, 16-pin SOIC Aerospace (-40°C to 105°C) Serial Space Grade (Gen 2) 16Mb 1.8V (1.71V to 2.00V) 3.0V (2.70V to 3.60V) 8-pin WSON, 8-pin SOIC Aerospace (-40°C to 125°C) | 1.8V (1.71V to 2.00V) 3.0V (2.70V to 3.60V) 36-ball FBGA Aerospace (-40°C to 125°C) Parallel x32 Space Grade (Gen 3) 512Mb, 1Gb, 2Gb, 4Gb 3.0V (2.70V to 3.60V) 142-ball FBGA | 1 Mb, 4Mb, 8Mb, 16Mb 3.0V (2.70V to 3.60V) 8-pad WSON, 8-pin SOIC Industrial (-40°C to 85°C), Industrial Plus (-40°C to 105°C) Parallel x8 1 Mb, 4Mb, 8Mb, 16Mb, 32Mb 3.0V (2.70V to 3.60V) 44-pin TSOP, 48-ball FBGA Industrial Plus (-40°C to 85°C), Industrial Plus (-40°C to 105°C) | |
| Voltages Packages Temperature Ranges Densities Voltages Packages Temperature Ranges | 1.8V (1.70V to 2.00V) 8-pin WSON, 16-pin SOIC Aerospace (-40°C to 105°C) Serial Space Grade (Gen 2) 16Mb 1.8V (1.71V to 2.00V) 3.0V (2.70V to 3.60V) 8-pin WSON, 8-pin SOIC Aerospace (-40°C to 125°C) | 1.8V (1.71V to 2.00V) 3.0V (2.70V to 3.60V) 36-ball FBGA Aerospace (-40°C to 125°C) Parallel x32 Space Grade (Gen 3) 512Mb, 1Gb, 2Gb, 4Gb 3.0V (2.70V to 3.60V) 142-ball FBGA | 1Mb, 4Mb, 8Mb, 16Mb 3.0V (2.70V to 3.60V) 8-pad WSON, 8-pin SOIC Industrial (-40°C to 85°C), Industrial Plus (-40°C to 105°C) Parallel x8 1Mb, 4Mb, 8Mb, 16Mb, 32Mb 3.0V (2.70V to 3.60V) 44-pin TSOP, 48-ball FBGA Industrial (-40°C to 85°C), Industrial Plus (-40°C to 105°C) | |
| Voltages Packages Temperature Ranges Densities Voltages Packages Temperature Ranges Densities | 1.8V (1.70V to 2.00V) 8-pin WSON, 16-pin SOIC Aerospace (-40°C to 105°C) Serial Space Grade (Gen 2) 16Mb 1.8V (1.71V to 2.00V) 3.0V (2.70V to 3.60V) 8-pin WSON, 8-pin SOIC Aerospace (-40°C to 125°C) Parallel x16 Space Grade (Gen 2) 16Mb, 32Mb, 64Mb | 1.8V (1.71V to 2.00V) 3.0V (2.70V to 3.60V) 36-ball FBGA Aerospace (-40°C to 125°C) Parallel x32 Space Grade (Gen 3) 512Mb, 1Gb, 2Gb, 4Gb 3.0V (2.70V to 3.60V) 142-ball FBGA | 1 Mb, 4Mb, 8Mb, 16Mb 3.0V (2.70V to 3.60V) 8-pad WSON, 8-pin SOIC Industrial (-40°C to 85°C), Industrial Plus (-40°C to 105°C) Parallel x8 1 Mb, 4Mb, 8Mb, 16Mb, 32Mb 3.0V (2.70V to 3.60V) 44-pin TSOP, 48-ball FBGA Industrial (-40°C to 85°C), Industrial Plus (-40°C to 105°C) | |

* Applicable to India region only

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| | | | Ser |
|-----------------------------------|--|-----------------------|------------------|
| | | Densities | 1 |
| | | Voltages | 1 |
| NASA Test Report | Application Notes Link | Packages | 8-p |
| Space qualified parts for MRAM | Migration from Cypress, Everspin & Fujitsu to Avalanche Technology | Temperature Ranges | Indust Indust |

| Internet of Things | | | |
|--------------------|--|------|--|
| | Serial Ultra Low Power | P | |
| ties | 1Mb, 4Mb, 8Mb, 16Mb | | |
| ges | 1.8V (1.71V to 2.00V) 3.0V (2.70V to 3.60V) | | |
| iges | 8-pad WSON, 8-pin SOIC | | |
| erature | Industrial (-40°C to 85°C), | As a | |

Instant access speed & non volatility characteristic a Level 3 cache to replace low performing NAND module As a high density PCI RAID controller

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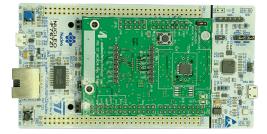
Storage STT-MRAM

avalanchetechnology





P-SRAM Development Kits



Serial QSPI Evaluation Kit

Enables users to evaluate Avalanche's P-SRAM Serial QSPI product using a STMicro Nucleo motherboard connected to an Avalanche daughter card via a standard Asynchronous SRAM interface. The Avalanche daughter card is populated with a AS3016204-108. The STMicro Nucleo motherboard communicates with the computer using a USB 2.0 cable type A/B and terminal emulator software, using Avalanche's proprietary software application.





Parallel Interface Evaluation Kit

Enables users to evaluate Avalanche's P-SRAM parallel interface product using a STMicro Nucleo motherboard connected to Avalanche's daughter card via a standard Asynchronous SRAM interface. The Avalanche parallel interface P-SRAM daughter card is populated with a AS3016316-035nX0I device. The STMicro Nucleo motherboard communicates with the computer using two USB 2.0 cables type A/B and terminal emulator software, using Avalanche's proprietary software application.

Arduino SPI Evaluation Board

Enables users to evaluate Avalanche's Serial P-SRAM products. The Avalanche P-SRAM evaluation board populated with a P-SRAM device can be connected to an Arduino UNO R3 or other host boards with compatible UNO R3 headers. Avalanche software bundled APIs and test program provide basic access to functionality of the Avalanche P-SRAM device.



Download the User Guide



Embedded Perpendicular STT-MRAM Technology (epMRAM)

Download the

User Guide

Avalanche's next generation epMRAM is fully integrated, energy efficient, has fast reads and writes, has no static leakage through MRAM bitcell and is ideal for IoT, storage and compute applications. epMRAM is offered in two flavors, namely, eMRAM and eSRAM.

epMRAM has excellent data endurance and retention characteristics; eMRAM: 1×10 Write Cycles with 20 years data retention at 85°C, eSRAM: 1×10¹⁶ Write Cycles with 20 years data retention at 85°C.

Avalanche's epMRAM can seamlessly replace embedded Flash (eFlash) and embedded SRAM (eSRAM) which are widely used in modern SoCs. eFlash and eSRAM are both facing scaling challenges beyond 28nm; eFlash due to limitations in channel length and endurance whilst eSRAM due to excessive leakage. Avalanche's epMRAM has no such challenges and is easily scalable to lower geometries (sub-10nm nodes).

Avalanche's eMRAM macros are enabled using standard manufacturing processes in existing CMOS FABs on top of the metal layer with two additional masks.

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